

H.B. Fuller Company Introduces Active Alignment (AA) Adhesives for Camera Module Assembly

New products to support growth in high-margin, high-growth electronics markets

ST. PAUL, Minn., Feb. 14, 2017 (GLOBE NEWSWIRE) -- H.B. Fuller Company (NYSE:FUL) announced today that it has introduced Active Alignment (AA) adhesives designed for camera module assembly at IPC APEX EXPO 2017 in San Diego, California.

A photo accompanying this announcement is available



H.B. Fuller's Active Alignment adhesives serve growing demand in electronics markets around the world.

at <http://www.globenewswire.com/NewsRoom/AttachmentNg/d8c4a28c-95e3-42da-9f6b-e330f262bf37>

At this year's IPC APEX EXPO, H.B. Fuller is connecting with attendees and showcasing its new AA adhesives in addition to the company's high performance, innovative adhesive solutions for electronics at **Booth 733**. H.B. Fuller has a global track record of recognizing trends and developing adhesive solutions to address industry challenges and changing market needs, particularly in the fast-growing and ever-changing electronics markets. Through close partnerships with electronics manufacturers around the world, the company has designed high performance adhesive solutions to respond to challenging application needs for electronic devices design and manufacturing process.

H.B. Fuller's platform chemistry innovation has enabled the development of the **EA6400 Series**, a high-performance, **AA adhesive solution** for camera lens assembly. The patent-pending chemistry, "LOTERA" (Low Temperature Cure, Enhanced Reliability Adhesive), enables H.B. Fuller to target a product-specific glass transition temperature (Tg) to a given customer requirement e.g. 0 to 150°C. This capability can provide an extra performance benefit of ensuring a stable product storage modulus in the standard operating range of the devices for reliability improvement.

"We continually look forward to engaging technical market challenges and solving problems that offer differentiated adhesives solutions to our electronics customers," says Matt Perry, global director, Engineering Adhesives, H.B. Fuller. "Active Alignment adhesives have further expanded our product portfolio to serve growing demand in electronics markets around the world."

H.B. Fuller's new products for camera module production, the **EA6400 Series**, offer customers a one-part, premixed adhesive solution with good RT work life. The products are formulated to offer high UV penetration at short UV exposure times (e.g. 2 -5 seconds), along with industry-leading, secondary thermal cure kinetics and lower temperature cure at short cure times. The formulation targets specific camera module substrates and shapes stability requirements (Rheology), while the high Tg capability enables a strong and more reliable bond.

About H.B. Fuller:

For 130 years, H.B. Fuller has been a leading global adhesives provider focusing on perfecting adhesives, sealants and other specialty chemical products to improve products and lives. With fiscal 2016 net revenue of \$2.1 billion, H.B. Fuller's commitment to innovation brings together people, products and processes that answer and solve some of the world's biggest challenges. Our reliable, responsive service creates lasting, rewarding connections with customers in electronics, disposable hygiene, medical, transportation, clean energy, packaging, construction, woodworking, general industries and other consumer businesses. And our promise to our people connects them with opportunities to innovate and thrive. For more information, visit us at www.hbfuller.com and subscribe to our blog.

About IPC APEX EXPO

IPC APEX EXPO 2017 is a five-day event in the printed circuit board and electronics manufacturing industry. Professionals from around the world come together to participate in the Technical Conference, Exhibition, and Professional Development, Standards Development and Certification programs. These activities offer seemingly endless education and networking opportunities that impact your career and company by providing you the knowledge, technical skills and best practices to address any challenge you face. For more information, visit at www.ipcapexexpo.org.

FOR MORE INFORMATION:

Remember Zhu
Business Communications
Global Engineering Adhesives
+86 133 9123 9392
remember.zhu@hbfuller.com

Kimberlee Sinclair
Director, Global Communications
+1 651-236-5823
kimberlee.sinclair@hbfuller.com

H.B. Fuller Company



H.B. Fuller

<https://investors.hbfuller.com/2017-02-14H-B-Fuller-Company-Introduces-Active-Alignment-AA-Adhesives-for-Camera-Module-Assembly>

Connecting what matters.™